

PHASE CONTROL IN THE CAPILLARY EVAPORATORS

CROSS REFERENCE TO RELATED APPLICATION

1. This application claims priority under 35 U.S.C. § 119(e) from provisional application no. 60/215,588, filed June 30, 2000. The 60/215,588 application is incorporated by reference herein, in its entirety, for all purposes.

INTRODUCTION

2. The present invention relates generally to the field of heat transport. More particularly, the present invention relates to loop heat pipes having plural capillary evaporator structures wherein phase of the working fluid is controlled to maintain system stability.

BACKGROUND OF THE INVENTION

3. Loop Heat pipes (LHPs) and Capillary Pumped Loops (CPLs) are passive two-phase heat transport systems that utilize the capillary pressure developed in a fine pored evaporator wick to circulate the system's working fluid. CPLs, which were developed in the United States, typically feature one or more capillary pumps or evaporators, while LHPs, which originated in the former Soviet Union, are predominantly single evaporator systems. The primary distinguishing characteristic between the two systems is the location of the loop's reservoir, which is used to store excess fluid displaced from the loop during operation. A reservoir of a CPL is located remotely from the evaporator and is cold biased using either the sink or the subcooled condensate return. On the other hand, the reservoir of an LHP is thermally and hydraulically coupled to the evaporator. This difference in reservoir location is responsible for the primary difference in the behavior of the two devices.

4. Referring to **Fig. 1**, the separation of the reservoir **110** from the plural, parallel evaporators **120** in a CPL is schematically illustrated. This separation makes it possible to construct thermal management loops that can incorporate any combination of series connected or parallel connected evaporators **120** and/or condensers **130**.

5. This feature offers distinct advantages for applications that require heat dissipation from large payload footprints or multiple separated heat sources. CPL's have also

demonstrated highly desirable thermal control/management properties such as sensitive temperature control properties that require only very modest application of heat to its reservoir, highly effective heat load sharing between evaporators that can totally eliminate the need for any heater energy to maintain inactive equipment at safe-mode temperatures, and heat sink (condenser) diode action which can provide protection from temporary exposure to hot environments.

6. Unfortunately, the advantages derived from a separated (remotely located) reservoir result in significant disadvantages that have limited the further evolution and application of CPL's. For example, CPL's are disadvantaged during start-up because the loop must first be preconditioned by heating the reservoir to prime the evaporator's wick before the heat source can be cooled. The principle disadvantage of CPL's, however, is its total reliance on subcooled liquid return to maintain stable operation at each and every evaporator capillary pump. As a consequence, CPL's require low conductivity wick materials to minimize their reliance on subcooling and impose constraints on tolerable system power and/or environment temperature cycling conditions.

7. On the other hand, referring to **Fig. 2**, a reservoir **210** of a LHP is co-located with the evaporator **220** and is thermally and hydraulically coupled to it with a conduit **230** that contains a capillary link **234** often referred to as a secondary wick. The interconnecting conduit **230** makes it possible to vent any vapor and/or bubbles of non-condensable gas (or "NCG bubbles") from the core of the evaporator **220** to the reservoir **210**. The capillary link **234**, on the other hand, makes it possible to pump liquid from the reservoir **210** to the evaporator **220**. This insures a wetted primary wick **224** during start-up, and prevents liquid depletion of the primary wick **224** during normal steady state operation and during transient temperature conditions of either the heat source **240** or the heat sink **250** (adjacent the condenser **260**). This architecture makes LHP's extremely robust and reliable, and makes preconditioning during start-up unnecessary. The control of vapor and liquid in the pump core provided by the secondary wick **234** minimizes the reliance of the loop on liquid subcooling. As a result, LHP's utilize metallic wicks, which offer an order of magnitude improvement in pumping capacity over the low conductivity wicks that are typically used in CPL's.

8. The problem with “robust” LHP’s is that they are limited to single evaporator/reservoir designs, which limit their application to heat sources with relatively small thermal footprints.

9. Ideally, a true thermal bus should incorporate the unrestricted combination of multiple evaporators and thermal management properties of a CPL together with the reliability and robustness of an LHP. One impediment to even greater utilization of the LHP is its limitation to single evaporator systems. Many applications require thermal control of large payload footprints or multiple separated heat sources that are best served by multiple evaporator LHP’s, which ideally would offer the same reliability and robustness as their single evaporator predecessors.

10. Several investigators have previously experimented with multiple evaporator LHP’s with mixed results. The effort of these investigators, summarized below, indicates that multiple evaporator LHP’s are only marginally feasible. These multiple evaporator LHP’s are limited in the number of evaporators that can be plumbed in parallel and/or are limited in the spatial separation between the evaporators.

11. Bienert *et al.* developed a breadboard LHP with two evaporators, each with its own compensation chamber (reservoir). Although the loop, which was charged with water, was designed without rigorous sizing and seemed to be sensitive to non-condensable gas, the breadboard made a proof-of-principle demonstration of the feasibility of a dual evaporator LHP. For further details, refer to Bienert, W., Wolf, D., and Nikitkin, M., “The Proof-Of-Feasibility Of Multiple Evaporator Loop Heat Pipe”, 6th European Symposium on Environmental Systems, May 1997.

12. More recently, the inventors of the present invention developed and demonstrated reliable operation of a dual evaporator LHP system, with a separate reservoir to each evaporator pump, was using ammonia as working fluid. Referring to **Fig. 3**, a schematic view of this dual evaporator LHP is illustrated. It has two parallel evaporator pumps **310**, **320**, each with its own reservoir **312**, **322**, vapor transport lines **314**, **324**, and liquid transport lines **316**, **326**, and a direct condensation condenser **330**. The reservoirs **312**, **322** were sized and the system charged to allow one reservoir to completely fill with liquid while the other reservoir remained partially filled at all operating conditions. The dual

evaporator/dual reservoir design clearly demonstrated comparable reliability and robustness as its single evaporator predecessors. For further details, refer to Yun, S., Wolf, D., and Kroliczek, E., "Design and Test Results of Multi-Evaporator Loop Heat Pipe", SAE Paper No. 1999-01-2051, 29th International Conference on Environmental Systems, July 1999.

13. However, there is limitation on the number of evaporators that can be reasonably used in multiple reservoir systems that are designed to operate over a wide temperature range. Referring to **Fig. 4**, a graphical analysis of hydro-accumulator sizing is illustrated for a typical LHP system designed for a maximum operating temperature of 65 °C. As the minimum operating temperature decreases, and the hydro-accumulator volume increases rapidly as the number of evaporators increases. As an example, at a minimum operating temperature of -40 °C, the volume of each hydro-accumulator increases by a factor of three between a two-evaporator system and a three-evaporator system. Over the same operating temperature range, a four-evaporator system would require an infinite hydro-accumulator volume.

14. Van Oost *et al.* developed a High Performance Capillary Pumping Loop (HPCPL) that included three parallel evaporators connected to the same reservoir. Referring to **Fig. 5**, a schematic view of the basic design of the HPCPL loop is illustrated. The reservoir **510** was co-located at the evaporator end of the loop, and included capillary links **512**, **514** between the evaporators **522**, **524** and the reservoir **510**, making the device similar to a LHP. The loop has been successfully tested on the ground with a favorable gravitational bias of the evaporators relative to the reservoir. This orientation constraint is due to limits imposed by the capillary links **512**, **514**. For further details, refer to Van Oost *et al.*, "Test Results of Reliable and Very High Capillary Multi-Evaporator / Condenser Loop", 25th International Conference on Environmental Systems, July 10-13, 1995.

15. Although this concept represents some advantages over a single evaporator LHP design, the capillary link **512**, **514** connecting the evaporators **522**, **524** to the reservoir **510** limits the separation between the evaporators and the reservoir. This limitation is similar to the transport and orientation limitations normally encountered with conventional heat pipes, as described by Kotlyarov *et al.*, "Methods of Increase of the Evaporators

Reliability for Loop Heat Pipes and Capillary Pumped Loop“, 24th International Conference on Environmental Systems, June 20-23, 1994.

16. The robustness of an LHP is derived from its ability to purge vapor/NCG bubbles via a path **516, 518** from the liquid core of the evaporator **522, 524** to the reservoir **510**. The disadvantage of the LHP is the limitation imposed by the heat pipe like characteristics of the capillary link. Hoang suggested (in a document entitled “Advanced Capillary Pumped Loop (A-CPL) Project Summary”, Contract No. NAS5-98103, March 1994) that such a link could itself be a loop and incorporated the idea in an Advanced Capillary Pumped Loop (A-CPL) concept which incorporates both the advantages of a robust LHP and the architectural flexibility of a CPL. An A-CPL system has been successfully co-developed and demonstrated by TTH Research, Inc. and Swales Aerospace.

17. Referring to **Fig. 6**, a schematic view of the A-CPL concept is illustrated. The A-CPL contains two conjoint independently operated loops - a main loop and an auxiliary loop. The main loop is basically a traditional CPL whose function is to transport the waste heat Q_V input at the evaporator capillary pump **610** and reject it to a heat sink via the primary condenser **620**. Hence, hardware and operational principles of the main loop are similar to those of a CPL. The auxiliary loop is utilized to remove vapor/NCG bubbles from the core of the evaporator capillary pump **610** and the reservoir capillary pump **630** and move them to the two-phase reservoir **640**. The auxiliary loop also provides Q_R heat transport from the reservoir capillary pump **630** to heat sinks via the auxiliary condenser **650** and the primary condenser **620**. In addition, the auxiliary loop is also employed to facilitate the start-up process. In this manner, the auxiliary loop functionally replaces the secondary wick in a conventional LHP.

18. An A-CPL prototype was fabricated and tested with the goal of demonstrating the basic feasibility of the concept. Referring to **Fig. 7**, a schematic view of the prototype loop is illustrated. The A-CPL prototype consisted of two 3-port nickel CPL evaporator pumps **710, 720** with a secondary loop driven by a reservoir capillary pump **730**. For this prototype, the reservoir capillary pump **730** was a “short” evaporator loop heat pipe (LHP), whose hydro-accumulator **732** also serves as the entire system’s reservoir. The LHP was used as the reservoir capillary pump **730** only to verify the functionality of the

secondary loop. In its final form, the A-CPL would be equipped with an reservoir capillary pump that is optimized for its specific function. Testing demonstrated the feasibility of:

- Operation of multiple, small diameter (< 1" OD) metal nickel wick
- Startup without pressure priming and liquid clearing of vapor line. (typical CPL startup process)
- Quick startup
- Robust operation under severe operational conditions (low power, power cycling, condenser cycling)

19. However, the above demonstration was achieved in series connected evaporator configuration only. This means that the secondary flow created by the reservoir capillary pump 730 flowed through the liquid cores of the evaporator pumps 710, 720 in series. Several tests were also conducted in parallel configuration. Results showed that the secondary flow preferentially went to the #1 evaporator pump 710, which has slightly less impedance in its liquid inlet line section than the #2 evaporator pump 720. This bias toward the #1 evaporator pump 710 made testing in a parallel configuration difficult to characterize.

SUMMARY OF THE INVENTION

20. It is an object of the present invention to provide a hybrid capillary pump loop (or "HCPL") arrangement that combines the thermal management features of a CPL with the robust and reliable operation of a LHP.

21. It is another object of the present invention to provide a capillary evaporator for use in an HCPL arrangement that combines the thermal management features of a CPL with the robust and reliable operation of a LHP.

22. It is yet another object of the present invention to provide a capillary evaporator that has a secondary liquid flow channel and a secondary vapor flow channel in addition to the primary liquid return line and the primary vapor exit line.

23. It is still another object of the present invention to provide a back pressure regulator for use in an HCPL arrangement that combines the thermal management features of a CPL with the robust and reliable operation of a LHP.

24. An HCPL system according to an embodiment of the present invention is a capillary pump two phase heat transport system that combines the most favorable characteristics of a CPL with the robustness and reliability of an LHP. Like a CPL, the HCPL consists of the following elements:

- Multiple parallel evaporators that make it possible to accommodate multiple independent heat sources
- Multiple parallel condensers that include capillary flow regulators to insure full utilization of the condenser independently of pressure drop and/or heat sink temperature variations
- Back pressure flow regulator(s) that allow(s) heat to be shared between evaporators

25. Unlike CPLs, however, an HCPL according to an embodiment of the present invention incorporates elements that form a secondary loop. That secondary loop is essentially a LHP that is co-joined with the CPL to form an inseparable whole. Although secondary to the basic thermal management of the HCPL thermal bus, the LHP loop portion of the system provides for the most essential operational functions that maintain healthy, robust and reliable operation. The function provided by the LHP is one of fluid management during start-up, steady state operation and heat sink/heat source temperature and power cycling.

26. Systems embodied according to the present invention accrue passive thermal management properties that include:

- robust and reliable performance characteristics during start-up
- robust and reliable performance characteristics during steady state operation
- robust and reliable performance characteristics during cycling of temperature and power at the heat sinks and the heat sources

27. Additional objects and advantages of the present invention will be apparent in the following detailed description read in conjunction with the accompanying drawing figures.

BRIEF DESCRIPTION OF THE DRAWINGS

28. Fig. 1 illustrates a schematic view a CPL.
29. Fig. 2 illustrates a schematic view a LHP.
30. Fig. 3 illustrates a schematic view of a dual evaporator LHP.
31. Fig. 4 illustrates with a graph an analysis of hydro-accumulator sizing in a multiple evaporator LHP.
32. Fig. 5 illustrates a schematic view of the basic design of a HPCPL loop.
33. Fig. 6 illustrates a schematic view of a A-CPL concept.
34. Fig. 7 illustrates a schematic view of a A-CPL prototype.
35. Fig. 8 illustrates a schematic view of a Hybrid CPL heat transport system according to an exemplary embodiment of the present invention.
36. Fig. 9 illustrates a schematic view of an evaporator for use in a Hybrid CPL heat transport system according to an exemplary embodiment of the present invention.
37. Fig. 10 illustrates a schematic view of a back pressure regulator for use in a Hybrid CPL heat transport system according to an exemplary embodiment of the present invention.

DETAILED DESCRIPTION OF THE INVENTION

38. Referring to **Fig. 8**, a schematic view of a Hybrid Capillary Pump Loop (HCPL) heat transport system according to an exemplary embodiment of the present invention is illustrated. The secondary loop consists of an LHP evaporator/reservoir assembly **810** that is plumbed in parallel with multiple modified CPL-type evaporators **820, 830** that are plumbed in parallel with one another. Fluid returning from the condensers **840** in the primary loop enters the liquid core of each modified CPL-type evaporators **820, 830** via a bayonet. In the core of each to the modified CPL-type evaporators **820, 830** the returned fluid is handled so that any liquid phase fluid is separated from any vapor or NCG bubbles

that may be generated during the operation of the HCPL and have found their way into the core.

39. Most of the liquid in the cores of each of the modified CPL-type evaporators **820**, **830** is pumped out through the primary wick. The balance of the liquid in each CPL evaporator core is coupled out via a secondary liquid flow channel **822**, **832** that has been connected in parallel to the liquid return supply of the LHP evaporator/reservoir assembly **810**. The vapor/NCG bubble portion that is separated out in the CPL evaporator core is coupled out via a secondary vapor flow channel **824**, **834** that has been connected in parallel to entering the void volume (vapor space) of the LHP reservoir **812** of the LHP evaporator/reservoir assembly **810**.

40. Thus, a secondary loop is formed by of an LHP evaporator/reservoir assembly **810** and multiple parallel secondary wick flow channels **822**, **832**, **824**, **834** in each modified CPL-type evaporator **820**, **830**. The secondary (LHP) loop shares a common primary vapor line **850** with the primary loop and also shares the liquid return **860** of the primary loop via the parallel connections described above.

41. Referring to **Fig. 9**, a schematic view of an evaporator for use in a HCPL heat transport system of **Fig. 8** is illustrated. The core of the modified CPL-type evaporator **820** incorporates a secondary wick **826**. Liquid returning from the condensers **840** in the primary loop enters modified CPL-type evaporator **820** core via a bayonet **828**. The secondary wick **826** separates the liquid phase in the evaporator core from any vapor or NCG bubbles that may be generated during the operation of the HCPL.

42. The secondary loop provides the HCPL with robust and reliable LHP type performance characteristics during start-up, steady state operation, and heat sink/heat source temperature and power cycling.

I. START-UP

43. Quick and reliable start-up is achieved by insuring appropriate liquid /vapor distribution. This is accomplished by simply applying heat to the LHP evaporator prior to initiating primary loop operation. Since the LHP evaporator is intimately connected to its reservoir that insures that the primary wick of the LHP evaporator is always wetted with liquid. Thus, reliable start-up of the secondary loop is always guaranteed. Once the

secondary loop has been started, favorable conditions are created in the remainder of the HCPL loop that guarantees reliable primary loop start-up. Preconditioning requirements are minimal since only the clearing of the vapor header of any liquid is required to achieve reliable start-up.

44. The ability to achieve quick reliable start-up of the HCPL is enhanced by the Back Pressure Regulator (BPR) **870** located at the inlet of the condenser **840**. Referring to **Fig. 10**, a schematic view of a BPR **870** according to the present invention is illustrated. The BPR **870** contains a wick structure **876** located within a fitting. One end **872** of the fitting extends into the condenser region where it is exposed to the heat sink. The other end **874** of the fitting extends into the vapor header section and is isolated from the heat sink. Prior to start-up, the wick structure **876** is saturated with liquid due to the exposure of one end **872** of the fitting to the heat sink. During start-up, the capillary action of the wick structure **876** prevents any vapor from flowing to the condenser thus insuring that all of the vapor channels in the primary loop are cleared of liquid before flow is initiated into the condenser. This guarantees a quick and reliable start-up.

45. Once start-up has been achieved, a pressure head is developed in the vapor passages that exceeds the capillary back pressure of the BPR. At this point, vapor can flow into the condenser and heat can be rejected to ambient. Vapor flow to the condenser will continue as long as sufficient heat is applied to the evaporators. However, if the heat is reduced below that which is required to maintain the evaporator at a given temperature (i.e. as the vapor flow to the condenser drops below a certain value) capillary action of the BPR wick will prevent any further vapor flow to the condenser. Thus, the BPR, in addition to aiding start-up, provides a means of achieving near 100% heat load sharing between evaporators.

II. NCG AND VAPOR BUBBLE MANAGEMENT

46. Management of NCG and/or vapor bubbles in the core of capillary pumped looped evaporators is important for the reliable operation of any two-phase loop. Management of vapor bubbles is especially critical since heat conducted across the wick will either create new vapor bubbles and/or provide the energy required to expand any preexisting bubbles. Once a bubble becomes sufficiently large, liquid flow blockage in the evaporator core will

result in primary wick deprime. Conventional LHPs are not susceptible to this kind of failure because the proximity of the reservoir allows venting of NCG/vapor bubbles from the evaporator core to the reservoir. Vented non-condensable gases (NCG) are stored in the reservoir void volume whereas, vapor bubbles are condensed, releasing the energy absorbed in the evaporator core due to the heat conduction across the primary wick. The condensate is returned to the evaporator core via a secondary wick.

47. In the HCPL the NCG/vapor bubble purging function is provided by the LHP Secondary Loop. Unlike prior attempts at connecting multiple evaporators to a central reservoir with individual secondary wicks (for example, the HPCPL arrangement proposed by Van Oost *et al.*), the secondary wicks in the HCPL are localized in each evaporator. The connection between each evaporator to the central reservoir is embodied as a plain smooth walled tubing devoid of any wick structure. Evaporators are connected in parallel thus allowing any number of evaporators to be interconnected irrespective of spatial separation.

48. Two steady state modes of operation are possible with the HCPL.

49. If a continuous heat load greater than or equal to the sum total heat conducted across all of the evaporator's secondary wicks is applied to the LHP evaporator, all liquid flowing to the evaporators will be supplied by the primary loop liquid line. Flow distribution between evaporators is controlled by the individual evaporator primary wicks which automatically adjust evaporator capillary pumping based on the heat load applied to the evaporator and by the individual evaporator secondary wicks which adjust evaporator core capillary pumping based on the heat conducted across individual wicks.

50. On the other hand, if no heat is applied to the LHP evaporator, only the liquid required to satisfy the pumping of the primary wick is provided by the primary loop liquid return. Vapor produced by the heat conducted through the evaporator wicks is condensed in the LHP reservoir and pumped back to the individual evaporator core by the secondary wicks.

51. In either case, flow distribution in HCPL loop is automatically and internally controlled by the capillary action of the primary and secondary wicks. This means that

liquid flow distribution is regulated by capillary action that adjusts itself automatically based on flow requirement and local pressure drops.

III. TRANSIENT MODE FLUID MANAGEMENT

52. Failures of most two-phase loops occur during transient modes of operation that require the shuttling between the reservoir and the condenser. This shuttling is required to either open or shut down the condenser in response to sink temperature and/or input power transients. Liquid movement out of the reservoir must be accompanied by vapor expansion in the reservoir. One undesirable effect of fluid shuttling can result if uncontrolled vapor expansion occurs in the evaporator core instead of the reservoir. However, vapor bubble expansion is more likely to occur in the evaporator core than the reservoir due to the availability of energy from heat being applied to the evaporator.

53. Uncontrolled expansion of a vapor bubble in an evaporator core can block liquid flow to the primary wick, followed by primary wick liquid starvation and ultimately leading to failure if the primary wick deprimed. The secondary wick is designed to regulate vapor bubble expansion in the core via the capillary action of the secondary wick which guarantees liquid access to the priming wick. Preferential displacement of liquid from the reservoir occurs since there is no restriction of vapor bubble expansion due to capillary action.

54. The present invention has been described in terms of preferred embodiments, however, it will be appreciated that various modifications and improvements may be made to the described embodiments without departing from the scope of the invention.